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FQB34N20

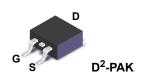
N-Channel QFET® MOSFET 200 V, 31 A, 75 mΩ

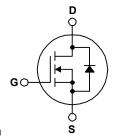
Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 31 A, 200 V, $R_{DS(on)}\,$ = 75 m Ω (Max.) @ V_{GS} = 10 V, I_D = 15.5 A
- Low Gate Charge (Typ. 60 nC)
- Low Crss (Typ. 55 pF)
- 100% Avalanche Tested
- RoHS Complianty





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQB34N20TM_AM002	Unit
V _{DSS}	Drain-Source Voltage		200	V
I _D	Drain Current - Continuous (T _C = 25°C)	1	31	Α
	- Continuous (T _C = 100°C	C)	20	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	124	Α
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	640	mJ
I _{AR}	Avalanche Current	(Note 1)	31	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	18	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
P_{D}	Power Dissipation (T _A = 25°C) *		3.13	W
	Power Dissipation (T _C = 25°C)		180	W
	- Derate above 25°C		1.43	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	Э	-55 to +150	°C
T _L	Maximum lead temperature for soldering por 1/8" from case for 5 seconds	urposes,	300	°C

Thermal Characteristics

Symbol	Parameter	FQB34N20TM_AM002	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.7	
В	Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper), Max.	62.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (* 1 in² pad of 2 oz copper), Max.	40	

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FQB34N20	FQB34N20TM-AM002	D2-PAK	330mm	24mm	800

Electrical Characteristics

T_C = 25°C unless otherwise noted

Symbol	Parameter	Parameter Test Conditions		Тур	Max	Unit
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.2		V/°C
I _{DSS}	Zoro Coto Voltago Droin Current	V _{DS} = 200 V, V _{GS} = 0 V			1	μА
	Zero Gate Voltage Drain Current	V _{DS} = 160 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
0 0						
On Cha	racteristics					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	3.0		5.0	V
	· · · · · · · · · · · · · · · · · · ·		1			

V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 15.5 A		0.06	0.075	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 15.5 A		25		S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$		2400	3100	pF
Coss	Output Capacitance	f = 1.0 MHz		430	560	pF
C _{rss}	Reverse Transfer Capacitance		-	55	70	pF

Switching Characteristics

t _{d(on)}	Turn-On Delay Time	V _{DD} = 100 V, I _D = 34 A,	 40	90	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$	 280	570	ns
t _{d(off)}	Turn-Off Delay Time	1.13 = 1.1	 125	260	ns
t _f	Turn-Off Fall Time	(Note 4)	 115	240	ns
Qg	Total Gate Charge	V _{DS} = 160 V, I _D = 34 A,	 60	78	nC
Q_{gs}	Gate-Source Charge	V _{GS} = 10 V	 17		nC
Q _{gd}	Gate-Drain Charge	(Note 4)	 27		nC

Drain-Source Diode Characteristics and Maximum Ratings

I _S	Maximum Continuous Drain-Source Diode Forward Current		 	31	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		 	124	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 31 A	 	1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 34 A,	 150		ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs	 0.95		μС

- Notes:
 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 1.0mH, I $_{AS}$ = 31A, V $_{DD}$ = 50V, R $_{G}$ = 25 Ω , Starting T $_{J}$ = 25°C 3. I $_{SD}$ ≤ 34A, di/dt ≤ 300A/ μ s, V $_{DD}$ ≤ BV $_{DSS}$, Starting T $_{J}$ = 25°C 4. Essentially independent of operating temperature

Typical Characteristics

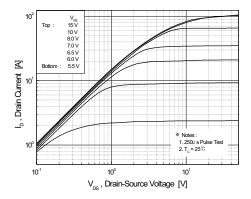


Figure 1. On-Region Characteristics

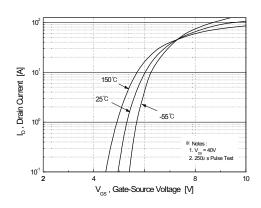


Figure 2. Transfer Characteristics

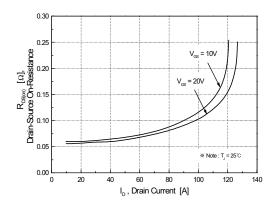


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

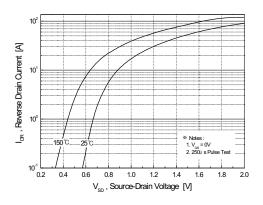


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

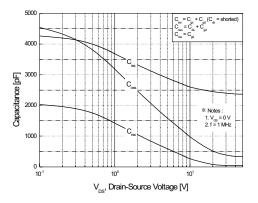


Figure 5. Capacitance Characteristics

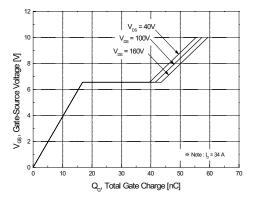


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

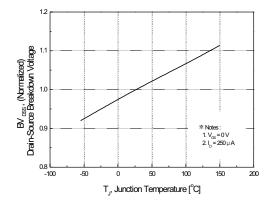


Figure 7. Breakdown Voltage Variation vs. Temperature

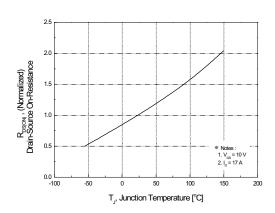


Figure 8. On-Resistance Variation vs. Temperature

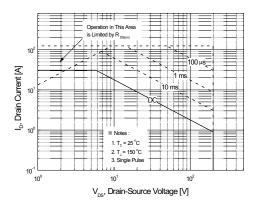


Figure 9. Maximum Safe Operating Area

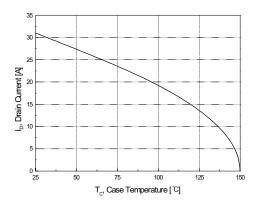


Figure 10. Maximum Drain Current vs. Case Temperature

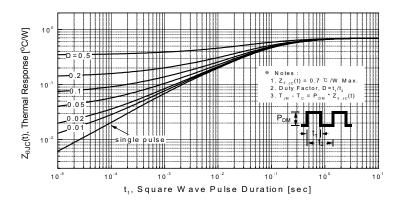


Figure 11. Transient Thermal Response Curve



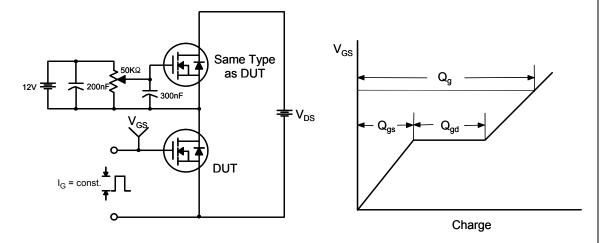


Figure 13. Resistive Switching Test Circuit & Waveforms

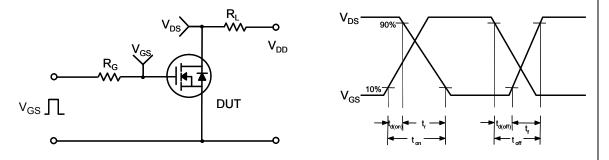
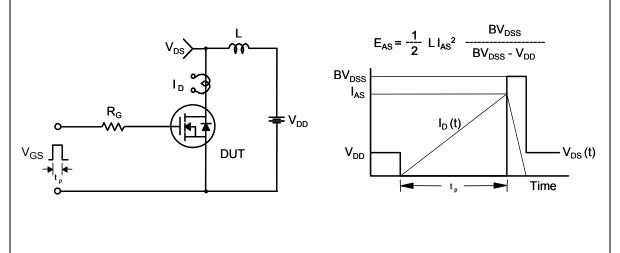


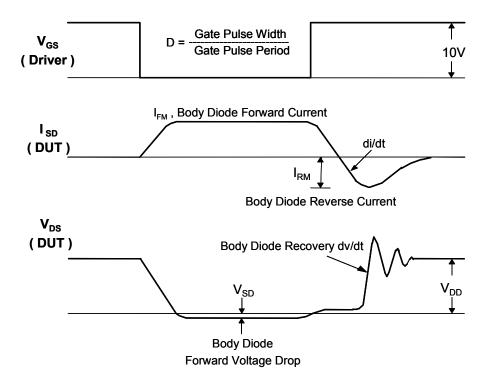
Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Driver
Same Type
as DUT

• dv/dt controlled by R_G
• I_{SD} controlled by pulse period

Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Mechanical Dimensions

TO-263 2L (D²PAK)

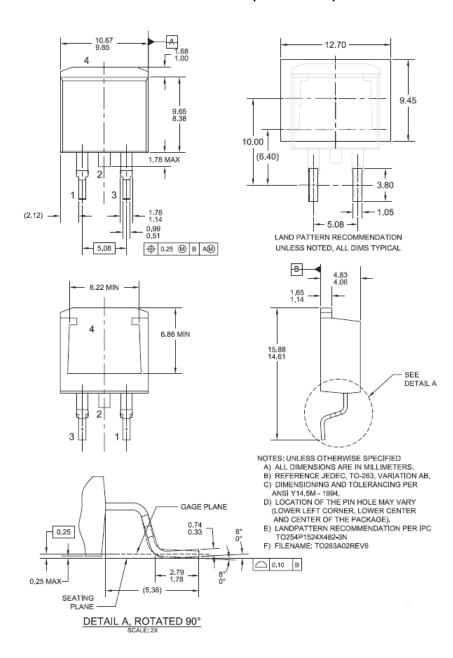


Figure 16. 2LD, TO263, Surface Mount

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Dimension in Millimeters

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